



Welcome to **E-XFL.COM** 

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Obsolete
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	CANbus, LINbus, SCI, SPI
Peripherals	LVD, POR, PWM
Number of I/O	21
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc68hc908gz16mfj





## **List of Chapters**

Chapter 1 General Description	19
Chapter 2 Memory	27
Chapter 3 Analog-to-Digital Converter (ADC)	47
Chapter 4 Clock Generator Module (CGM)	59
Chapter 5 Configuration Register (CONFIG)	79
Chapter 6 Computer Operating Properly (COP) Module	83
Chapter 7 Central Processor Unit (CPU)	87
Chapter 8 External Interrupt (IRQ)	99
Chapter 9 Keyboard Interrupt Module (KBI)	103
Chapter 10 Low-Power Modes	109
Chapter 11 Low-Voltage Inhibit (LVI)	117
Chapter 12 MSCAN08 Controller (MSCAN08)	121
Chapter 13 Input/Output (I/O) Ports	155
Chapter 14 Resets and Interrupts	169
Chapter 15 Enhanced Serial Communications Interface (ESCI) Module	181
Chapter 16 System Integration Module (SIM)	213
Chapter 17 Serial Peripheral Interface (SPI) Module	231
Chapter 18 Timebase Module (TBM)	251
Chapter 19 Timer Interface Module (TIM)	255
Chapter 20 Development Support	271
Chapter 21 Electrical Specifications	287
Chapter 22 Ordering Information and Mechanical Specifications	303
Appendix A MC68HC908GZ8	311



#### **Table of Contents**

## Chapter 11 Low-Voltage Inhibit (LVI)

11.1	Introduction	117
11.2	Features	117
11.3	Functional Description	
11.3.1	Polled LVI Operation	
11.3.2	Forced Reset Operation.	
11.3.3	Voltage Hysteresis Protection	
11.3.4	LVI Trip Selection	
11.4	LVI Status Register	
11.5	LVI Interrupts	
11.6	Low-Power Modes	
11.6.1	Wait Mode	
11.6.2	Stop Mode	
11.0.2	Otop Wode	120
	Chapter 12	
	MSCAN08 Controller (MSCAN08)	
12.1	Introduction	121
12.2	Features	121
12.3	External Pins	122
12.4	Message Storage	
12.4.1	Background	
12.4.2	Receive Structures	
12.4.3	Transmit Structures	
12.5	Identifier Acceptance Filter	
12.6	Interrupts	
12.6.1	Interrupt Acknowledge	
12.6.2	Interrupt Vectors	
12.7	Protocol Violation Protection	
12.8	Low-Power Modes	
12.8.1	MSCAN08 Sleep Mode	
12.8.2	MSCAN08 Soft Reset Mode	
12.8.3	MSCAN08 Power-Down Mode	
12.8.4	CPU Wait Mode	
12.8.5	Programmable Wakeup Function	
	Timer Link	
12.10	Clock System	
12.11	Memory Map	
	Programmer's Model of Message Storage	
12.12 12.12.1		
12.12.1 12.12.2		
12.12.2 12.12.3		
12.12.3 12.12.4		
12.12.2 12.12.5		
	Programmer's Model of Control Registers	
12.13 12.13.1	<u> </u>	
12.13.1 12.13.2		
14.13.4	iviocativos iviodule control negister i	143

MC68HC908GZ16 • MC68HC908GZ8 Data Sheet, Rev. 4



## 4.4 I/O Signals

The following paragraphs describe the CGM I/O signals.

## 4.4.1 Crystal Amplifier Input Pin (OSC1)

The OSC1 pin is an input to the crystal oscillator amplifier.

#### 4.4.2 Crystal Amplifier Output Pin (OSC2)

The OSC2 pin is the output of the crystal oscillator inverting amplifier.

### 4.4.3 External Filter Capacitor Pin (CGMXFC)

The CGMXFC pin is required by the loop filter to filter out phase corrections. An external filter network is connected to this pin. (See Figure 4-2.)

#### NOTE

To prevent noise problems, the filter network should be placed as close to the CGMXFC pin as possible, with minimum routing distances and no routing of other signals across the network.

## 4.4.4 PLL Analog Power Pin (V<sub>DDA</sub>)

 $V_{DDA}$  is a power pin used by the analog portions of the PLL. Connect the  $V_{DDA}$  pin to the same voltage potential as the  $V_{DD}$  pin.

#### NOTE

Route  $V_{DDA}$  carefully for maximum noise immunity and place bypass capacitors as close as possible to the package.

## 4.4.5 PLL Analog Ground Pin (V<sub>SSA</sub>)

 $V_{SSA}$  is a ground pin used by the analog portions of the PLL. Connect the  $V_{SSA}$  pin to the same voltage potential as the  $V_{SS}$  pin.

#### NOTE

Route  $V_{SSA}$  carefully for maximum noise immunity and place bypass capacitors as close as possible to the package.

## 4.4.6 Oscillator Enable Signal (SIMOSCEN)

The SIMOSCEN signal comes from the system integration module (SIM) and enables the oscillator and PLL.

#### 4.4.7 Oscillator Stop Mode Enable Bit (OSCSTOPENB)

OSCSTOPENB is a bit in the CONFIG register that enables the oscillator to continue operating during stop mode. If this bit is set, the Oscillator continues running during stop mode. If this bit is not set (default), the oscillator is controlled by the SIMOSCEN signal which will disable the oscillator during stop mode.



#### **Central Processor Unit (CPU)**

Table 7-1. Instruction Set Summary (Sheet 3 of 6)

Source	Operation	Description				ect	Ct C Address Mode			Opcode	Operand	les
Form	оролино		٧	Н	I	Ν	Z	С	Add	Opc	Ope	Cycles
CLR opr CLRA CLRX CLRH CLR opr,X CLR ,X CLR opr,SP	Clear	$\begin{array}{l} M \leftarrow \$00 \\ A \leftarrow \$00 \\ X \leftarrow \$00 \\ X \leftarrow \$00 \\ H \leftarrow \$00 \\ M \leftarrow \$00 \\ M \leftarrow \$00 \\ M \leftarrow \$00 \\ M \leftarrow \$00 \end{array}$	0	_	ı	0	1	_	DIR INH INH INH IX1 IX SP1	3F 4F 5F 8C 6F 7F 9E6F	dd ff ff	3 1 1 3 2 4
CMP #opr CMP opr CMP opr, CMP opr,X CMP opr,X CMP,X CMP opr,SP CMP opr,SP	Compare A with M	(A) – (M)	ţ	_		<b>‡</b>	‡	1	IMM DIR EXT IX2 IX1 IX SP1 SP2	A1 B1 C1 D1 E1 F1 9EE1 9ED1	ii dd hh II ee ff ff ee ff	2 3 4 4 3 2 4 5
COM opr COMA COMX COM opr,X COM ,X COM opr,SP	$ \begin{array}{c} M \leftarrow (\overline{\mathbb{M}}) = \$FF - (M) \\ A \leftarrow (\underline{A}) = \$FF - (M) \\ X \leftarrow (X) = \$FF - (M) \\ M \leftarrow (M) = \$FF - (M) \\ \end{array} $				- 1	1	‡	1	DIR INH INH IX1 IX SP1	33 43 53 63 73 9E63	dd ff ff	4 1 1 4 3 5
CPHX #opr CPHX opr	Compare H:X with M (H:X) - (M:M + 1)				_	‡	‡	‡	IMM DIR	65 75	ii ii+1 dd	3
CPX #opr CPX opr CPX opr CPX ,X CPX opr,X CPX opr,X CPX opr,SP CPX opr,SP	Compare X with M	(X) – (M)			_	‡	1	Į.	IMM DIR EXT IX2 IX1 IX SP1 SP2	A3 B3 C3 D3 E3 F3 9EE3 9ED3		2 3 4 4 3 2 4 5
DAA	Decimal Adjust A	(A) <sub>10</sub>	U	-	-	1	1	1	INH	72		2
DBNZ opr,rel DBNZA rel DBNZX rel DBNZ opr,X,rel DBNZ X,rel DBNZ opr,SP,rel	Decrement and Branch if Not Zero	$\begin{array}{l} A \leftarrow (A)-1 \text{ or } M \leftarrow (M)-1 \text{ or } X \leftarrow (X)-1 \\ PC \leftarrow (PC)+3+\mathit{rel}? \text{ (result)} \neq 0 \\ PC \leftarrow (PC)+2+\mathit{rel}? \text{ (result)} \neq 0 \\ PC \leftarrow (PC)+2+\mathit{rel}? \text{ (result)} \neq 0 \\ PC \leftarrow (PC)+3+\mathit{rel}? \text{ (result)} \neq 0 \\ PC \leftarrow (PC)+3+\mathit{rel}? \text{ (result)} \neq 0 \\ PC \leftarrow (PC)+2+\mathit{rel}? \text{ (result)} \neq 0 \\ PC \leftarrow (PC)+4+\mathit{rel}? \text{ (result)} \neq 0 \end{array}$	_	_	ı	-	ı	_	DIR INH INH IX1 IX SP1	3B 4B 5B 6B 7B 9E6B	dd rr rr rr ff rr rr ff rr	533546
DEC opr DECA DECX DEC opr,X DEC ,X DEC opr,SP	Decrement $ \begin{array}{c} M \leftarrow (M)-1 \\ A \leftarrow (A)-1 \\ X \leftarrow (X)-1 \\ M \leftarrow (M)-1 \\ M \leftarrow (M)-1 \\ M \leftarrow (M)-1 \end{array} $		Į.	_	-	<b>1</b>	1	_	DIR INH INH IX1 IX SP1	3A 4A 5A 6A 7A 9E6A	dd ff ff	4 1 1 4 3 5
DIV	Divide	$A \leftarrow (H:A)/(X)$ $H \leftarrow Remainder$	_	-	-	-	‡	‡	INH	52		7
EOR #opr EOR opr EOR opr, EOR opr,X EOR opr,X EOR,X EOR opr,SP EOR opr,SP	Exclusive OR M with A	$A \leftarrow (A \oplus M)$	0	_	ı	‡	‡	_	IMM DIR EXT IX2 IX1 IX SP1 SP2	A8 B8 C8 D8 E8 F8 9EE8 9ED8	ii dd hh II ee ff ff ee ff	2 3 4 4 3 2 4 5
INC opr INCA INCX INC opr,X INC ,X INC opr,SP	Increment	$M \leftarrow (M) + 1$ $A \leftarrow (A) + 1$ $X \leftarrow (X) + 1$ $M \leftarrow (M) + 1$ $M \leftarrow (M) + 1$ $M \leftarrow (M) + 1$	Î	_	-	1	‡	_	DIR INH INH IX1 IX SP1	3C 4C 5C 6C 7C 9E6C	dd ff ff	4 1 1 4 3 5



## 10.16 Exiting Stop Mode

These events restart the system clocks and load the program counter with the reset vector or with an interrupt vector:

- External reset A logic 0 on the RST pin resets the MCU and loads the program counter with the contents of locations \$FFFE and \$FFFF.
- External interrupt A high-to-low transition on an external interrupt pin loads the program counter with the contents of locations:
  - \$FFFA and \$FFFB; IRQ pin
  - \$FFE0 and \$FFE1; keyboard interrupt pins
- Low-voltage inhibit (LVI) reset A power supply voltage below the LVI<sub>TRIPF</sub> voltage resets the MCU and loads the program counter with the contents of locations \$FFFE and \$FFFF.
- Timebase module (TBM) interrupt A TBM interrupt loads the program counter with the contents of locations \$FFDC and \$FFDD when the timebase counter has rolled over. This allows the TBM to generate a periodic wakeup from stop mode.
- MSCAN08 interrupt MSCAN08 bus activity can wake the MCU from CPU stop. However, until
  the oscillator starts up and synchronization is achieved the MSCAN08 will not respond to incoming
  data.

Upon exit from stop mode, the system clocks begin running after an oscillator stabilization delay. A 12-bit stop recovery counter inhibits the system clocks for 4096 CGMXCLK cycles after the reset or external interrupt.

The short stop recovery bit, SSREC, in the CONFIG1 register controls the oscillator stabilization delay during stop recovery. Setting SSREC reduces stop recovery time from 4096 CGMXCLK cycles to 32 CGMXCLK cycles.

#### NOTE

Use the full stop recovery time (SSREC = 0) in applications that use an external crystal.



#### 11.3.3 Voltage Hysteresis Protection

Once the LVI has triggered (by having  $V_{DD}$  fall below  $V_{TRIPF}$ ), the LVI will maintain a reset condition until  $V_{DD}$  rises above the rising trip point voltage,  $V_{TRIPR}$ . This prevents a condition in which the MCU is continually entering and exiting reset if  $V_{DD}$  is approximately equal to  $V_{TRIPF}$ .  $V_{TRIPR}$  is greater than  $V_{TRIPF}$  by the hysteresis voltage,  $V_{HYS}$ .

#### 11.3.4 LVI Trip Selection

The LVI5OR3 bit in the configuration register selects whether the LVI is configured for 5-V or 3-V protection.

#### NOTE

The microcontroller is guaranteed to operate at a minimum supply voltage. The trip point ( $V_{TRIPF}$  [5 V] or  $V_{TRIPF}$  [3 V]) may be lower than this. See Chapter 21 Electrical Specifications for the actual trip point voltages.

## 11.4 LVI Status Register

The LVI status register (LVISR) indicates if the  $V_{DD}$  voltage was detected below the  $V_{TRIPF}$  level.

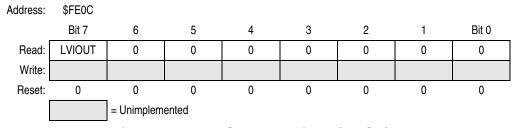


Figure 11-3. LVI Status Register (LVISR)

#### LVIOUT — LVI Output Bit

This read-only flag becomes set when the  $V_{DD}$  voltage falls below the  $V_{TRIPF}$  trip voltage (see Table 11-1). Reset clears the LVIOUT bit.

Table 11-1. LVIOUT Bit Indication

V <sub>DD</sub>	LVIOUT
V <sub>DD</sub> > V <sub>TRIPR</sub>	0
$V_{DD} < V_{TRIPF}$	1
V <sub>TRIPF</sub> < V <sub>DD</sub> < V <sub>TRIPR</sub>	Previous value

## 11.5 LVI Interrupts

The LVI module does not generate interrupt requests.



# Chapter 13 Input/Output (I/O) Ports

#### 13.1 Introduction

Bidirectional input-output (I/O) pins form five parallel ports. All I/O pins are programmable as inputs or outputs. All individual bits within port A, port C, and port D are software configurable with pullup devices if configured as input port bits. The pullup devices are automatically and dynamically disabled when a port bit is switched to output mode.

#### 13.2 Unused Pin Termination

Input pins and I/O port pins that are not used in the application must be terminated. This prevents excess current caused by floating inputs, and enhances immunity during noise or transient events. Termination methods include:

- 1. Configuring unused pins as outputs and driving high or low;
- 1. Configuring unused pins as inputs and enabling internal pull-ups;
- 1. Configuring unused pins as inputs and using external pull-up or pull-down resistors.

Never connect unused pins directly to V<sub>DD</sub> or V<sub>SS</sub>.

Since some general-purpose I/O pins are not available on all packages, these pins must be terminated as well. Either method 1 or 2 above are appropriate.

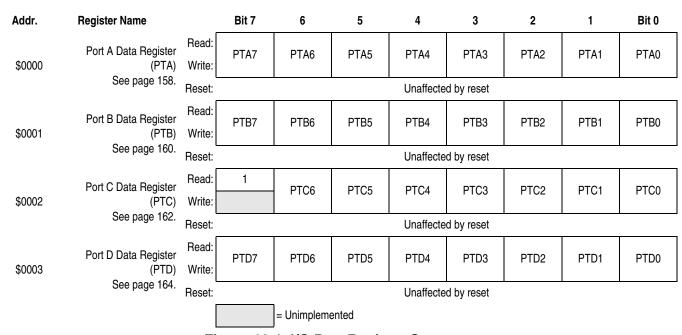


Figure 13-1. I/O Port Register Summary

MC68HC908GZ16 • MC68HC908GZ8 Data Sheet, Rev. 4



#### Input/Output (I/O) Ports

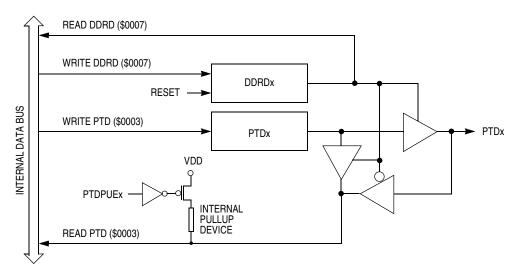


Figure 13-15. Port D I/O Circuit

When bit DDRDx is a logic 1, reading address \$0003 reads the PTDx data latch. When bit DDRDx is a logic 0, reading address \$0003 reads the voltage level on the pin. The data latch can always be written, regardless of the state of its data direction bit. Table 13-5 summarizes the operation of the port D pins.

PTDPUE	DDRD	PTD	I/O Pin	Accesses to DDRD	Access	ses to PTD
Bit	Bit	Bit	Mode	Read/Write	Read	Write
1	0	X <sup>(1)</sup>	Input, V <sub>DD</sub> <sup>(2)</sup>	DDRD7-DDRD0	Pin	PTD7-PTD0 <sup>(3)</sup>
0	0	Х	Input, Hi-Z <sup>(4)</sup>	DDRD7-DDRD0	Pin	PTD7-PTD0 <sup>(3)</sup>
Х	1	Х	Output	DDRD7-DDRD0	PTD7-PTD0	PTD7-PTD0

**Table 13-5. Port D Pin Functions** 

- 1. X = Don't care
- 2. I/O pin pulled up to  $V_{\mbox{\scriptsize DD}}$  by internal pullup device.
- 3. Writing affects data register, but does not affect input.
- 4. Hi-Z = High impedance

#### 13.6.3 Port D Input Pullup Enable Register

The port D input pullup enable register (PTDPUE) contains a software configurable pullup device for each of the eight port D pins. Each bit is individually configurable and requires that the data direction register, DDRD, bit be configured as an input. Each pullup is automatically and dynamically disabled when a port bit's DDRD is configured for output mode.

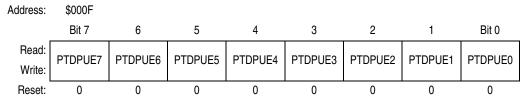


Figure 13-16. Port D Input Pullup Enable Register (PTDPUE)

MC68HC908GZ16 • MC68HC908GZ8 Data Sheet, Rev. 4



After every instruction, the CPU checks all pending interrupts if the I bit is not set. If more than one interrupt is pending when an instruction is done, the highest priority interrupt is serviced first. In the example shown in Figure 14-4, if an interrupt is pending upon exit from the interrupt service routine, the pending interrupt is serviced before the LDA instruction is executed.

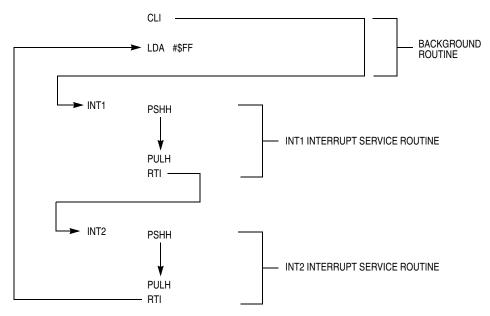


Figure 14-4. Interrupt Recognition Example

The LDA opcode is prefetched by both the INT1 and INT2 RTI instructions. However, in the case of the INT1 RTI prefetch, this is a redundant operation.

#### NOTE

To maintain compatibility with the M6805 Family, the H register is not pushed on the stack during interrupt entry. If the interrupt service routine modifies the H register or uses the indexed addressing mode, save the H register and then restore it prior to exiting the routine.

See Figure 14-5 for a flowchart depicting interrupt processing.

#### **14.3.2 Sources**

The sources in Table 14-1 can generate CPU interrupt requests.

#### 14.3.2.1 Software Interrupt (SWI) Instruction

The software interrupt (SWI) instruction causes a non-maskable interrupt.

#### NOTE

A software interrupt pushes PC onto the stack. An SWI does **not** push PC – 1, as a hardware interrupt does.

#### 14.3.2.2 Break Interrupt

The break module causes the CPU to execute an SWI instruction at a software-programmable break point.

MC68HC908GZ16 • MC68HC908GZ8 Data Sheet, Rev. 4



#### **Resets and Interrupts**

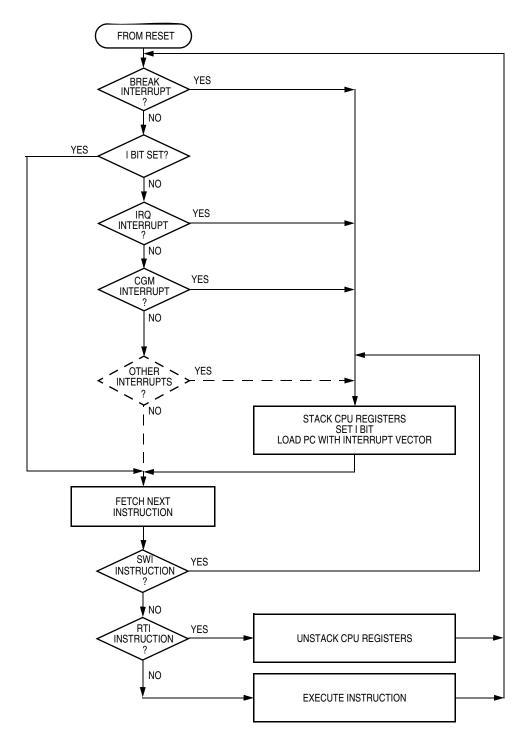


Figure 14-5. Interrupt Processing



**Table 14-1. Interrupt Sources** 

Source	Flag	Mask <sup>(1)</sup>	INT Register Flag	Priority <sup>(2)</sup>	Vector Address
Reset	None	None	None	0	\$FFFE—\$FFFF
SWI instruction	None	None	None	0	\$FFFC—\$FFFD
ĪRQ pin	IRQF	IMASK1	IF1	1	\$FFFA—\$FFFB
CGM change in lock	PLLF	PLLIE	IF2	2	\$FFF8-\$FFF9
TIM1 channel 0	CH0F	CH0IE	IF3	3	\$FFF6-\$FFF7
TIM1 channel 1	CH1F	CH1IE	IF4	4	\$FFF4-\$FFF5
TIM1 overflow	TOF	TOIE	IF5	5	\$FFF2-\$FFF3
TIM2 channel 0	CH0F	CH0IE	IF6	6	\$FFF0-\$FFF1
TIM2 channel 1	CH1F	CH1IE	IF7	7	\$FFEE-\$FFEF
TIM2 overflow	TOF	TOIE	IF8	8	\$FFEC-\$FFED
SPI receiver full	SPRF	SPRIE			
SPI overflow	OVRF	ERRIE	IF9	9	\$FFEA-\$FFEB
SPI mode fault	MODF	ERRIE			
SPI transmitter empty	SPTE	SPTIE	IF10	10	\$FFE8-\$FFE9
SCI receiver overrun	OR	ORIE			
SCI noise flag	NF	NEIE	lea a		<b>45550 45557</b>
SCI framing error	FE	FEIE	IF11	11	\$FFE6-\$FFE7
SCI parity error	PE	PEIE			
SCI receiver full	SCRF	SCRIE	1540	40	<b>45554 45555</b>
SCI input idle	IDLE	ILIE	IF12	12	\$FFE4-\$FFE5
SCI transmitter empty	SCTE	SCTIE	1540	40	ΦΕΕΕΟ ΦΕΕΕΟ
SCI transmission complete	TC	TCIE	IF13	13	\$FFE2-\$FFE3
Keyboard pin	KEYF	IMASKK	IF14	14	\$FFE0-\$FFE1
ADC conversion complete	COCO	AIEN	IF15	15	\$FFDE-\$FFDF
Timebase	TBIF	TBIE	IF16	16	\$FFDC-\$FFDD
MSCAN08 receiver wakeup	WUPIF	WUPIE	IF17	17	\$FFDA-\$FFDB
MSCAN08 error	RWRNIF TWRNIF RERIF TERRIF BOFFIF OVRIF	RWRNIE TWRNIE RERRIE TERRIE BOFFIE OVRIE	IF18	18	\$FFD8-\$FFD9
MSCAN08 receiver	RXF	RXFIE	IF19	19	\$FFD6-\$FFD7
MSCAN08 transmitter	TXE2 TXE1 TXE0	TXEIE2 TXEIE1 TXEIE0	IF20	20	\$FFD4-\$FFD5

<sup>1.</sup> The I bit in the condition code register is a global mask for all interrupt sources except the SWI instruction. 2. 0 = highest priority



# Chapter 15 Enhanced Serial Communications Interface (ESCI) Module

#### 15.1 Introduction

The enhanced serial communications interface (ESCI) module allows asynchronous communications with peripheral devices and other microcontroller units (MCU).

#### 15.2 Features

#### Features include:

- Full-duplex operation
- Standard mark/space non-return-to-zero (NRZ) format
- Programmable baud rates
- Programmable 8-bit or 9-bit character length
- Separately enabled transmitter and receiver
- Separate receiver and transmitter central processor unit (CPU) interrupt requests
- Programmable transmitter output polarity
- Two receiver wakeup methods:
  - Idle line wakeup
  - Address mark wakeup
- Interrupt-driven operation with eight interrupt flags:
  - Transmitter empty
  - Transmission complete
  - Receiver full
  - Idle receiver input
  - Receiver overrun
  - Noise error
  - Framing error
  - Parity error
- Receiver framing error detection
- Hardware parity checking
- 1/16 bit-time noise detection



#### **Enhanced Serial Communications Interface (ESCI) Module**

#### 15.9.4 Arbitration Mode

If AM[1:0] is set to 10, the arbiter module operates in arbitration mode. On every rising edge of SCI\_TxD (output of the ESCI module, internal chip signal), the counter is started. When the counter reaches \$38 (ACLK = 0) or \$08 (ACLK = 1), RxD is statically sensed. If in this case, RxD is sensed low (for example, another bus is driving the bus dominant) ALOST is set. As long as ALOST is set, the TxD pin is forced to 1, resulting in a seized transmission.

If SCI\_TxD is sensed logic 0 without having sensed a logic 0 before on RxD, the counter will be reset, arbitration operation will be restarted after the next rising edge of SCI\_TxD.



The CPU can always read the state of the  $\overline{SS}$  pin by configuring the appropriate pin as an input and reading the port data register. See Table 17-3.

SPE	SPMSTR	MODFEN	SPI Configuration	State of SS Logic
0	X <sup>(1))</sup>	х	Not enabled	General-purpose I/O; SS ignored by SPI
1	0	Х	Slave	Input-only to SPI
1	1	0	Master without MODF	General-purpose I/O; SS ignored by SPI
1	1	1	Master with MODF	Input-only to SPI

**Table 17-3. SPI Configuration** 

## 17.12.5 CGND (Clock Ground)

CGND is the ground return for the serial clock pin, SPSCK, and the ground for the port output buffers. It is internally connected to  $V_{SS}$  as shown in Table 17-1.

## 17.13 I/O Registers

Three registers control and monitor SPI operation:

- SPI control register (SPCR)
- · SPI status and control register (SPSCR)
- SPI data register (SPDR)

#### 17.13.1 SPI Control Register

The SPI control register:

- Enables SPI module interrupt requests
- Configures the SPI module as master or slave
- · Selects serial clock polarity and phase
- Configures the SPSCK, MOSI, and MISO pins as open-drain outputs
- Enables the SPI module

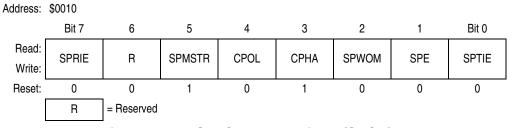


Figure 17-14. SPI Control Register (SPCR)

#### SPRIE — SPI Receiver Interrupt Enable Bit

This read/write bit enables CPU interrupt requests generated by the SPRF bit. The SPRF bit is set when a byte transfers from the shift register to the receive data register. Reset clears the SPRIE bit.

- 1 = SPRF CPU interrupt requests enabled
- 0 = SPRF CPU interrupt requests disabled

MC68HC908GZ16 • MC68HC908GZ8 Data Sheet, Rev. 4

<sup>1.</sup> X = Don't care



# **Chapter 19 Timer Interface Module (TIM)**

#### 19.1 Introduction

This section describes the timer interface (TIM) module. The TIM is a two-channel timer that provides a timing reference with input capture, output compare, and pulse-width-modulation functions. Figure 19-1 is a block diagram of the TIM.

This particular MCU has two timer interface modules which are denoted as TIM1 and TIM2.

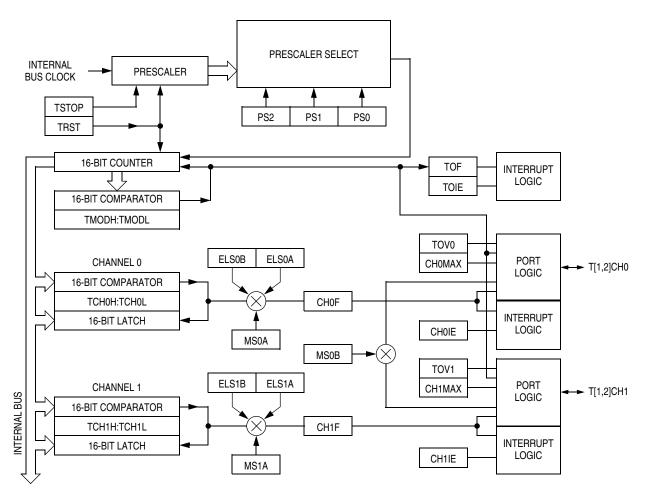


Figure 19-1. TIM Block Diagram



#### **Timer Interface Module (TIM)**

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0	
	Timer 1 Status and Control	Read:	TOF	TOIL	TOTOD	0	0	PS2	DC1	PS0	
\$0020	Register (T1SC)	Write:	0	TOIE	TSTOP	TRST		P32	PS1	P30	
	See page 265.	Reset:	0	0	1	0	0	0	0	0	
	Timer 1 Counter	Read:	Bit 15	14	13	12	11	10	9	Bit 8	
\$0021	,	Write:									
	See page 266.	Reset:	0	0	0	0	0	0	0	0	
	Timer 1 Counter	Read:	Bit 7	6	5	4	3	2	1	Bit 0	
\$0022	Register Low (T1CNTL)	Write:									
	See page 266.	Reset:	0	0	0	0	0	0	0	0	
\$0023	Timer 1 Counter Modulo Register High (T1MODH)	Read: Write:	Bit 15	14	13	12	11	10	9	Bit 8	
See page 267.	Reset:	1	1	1	1	1	1	1	1		
\$0024	Timer 1 Counter Modulo Register Low (T1MODL)	Read: Write:	Bit 7	6	5	4	3	2	1	Bit 0	
See page 267.	Reset:	1	1	1	1	1	1	1	1		
	Timer 1 Channel 0 Status and \$0025 Control Register (T1SC0)	Read:	CH0F	CH0IE	MS0B	MS0A	ELS0B	ELS0A	TOV0	CH0MAX	
		Write:	0	CHUIE	IVIOUD	IVIOUA	LLOUD	ELSUA	1000	CHUIVIAX	
	See page 267.	Reset:	0	0	0	0	0	0	0	0	
\$0026	Timer 1 Channel 0 Register High (T1CH0H)	Read: Write:	Bit 15	14	13	12	11	10	9	Bit 8	
	See page 270.	Reset:	Indeterminate after reset								
\$0027	Timer 1 Channel 0 Register Low (T1CH0L)	Read: Write:	Bit 7	6	5	4	3	2	1	Bit 0	
	See page 270.	Reset:	Indeterminate after reset								
	Timer 1 Channel 1 Status and	Read:	CH1F		0						
\$0028	Control Register (T1SC1)	Write:	0	CH1IE		MS1A	ELS1B	ELS1A	TOV1	CH1MAX	
	See page 267.	Reset:	0	0	0	0	0	0	0	0	
\$0029	Timer 1 Channel 1 Register High (T1CH1H)	Read: Write:	Bit 15	14	13	12	11	10	9	Bit 8	
	See page 270.	Reset:		Indeterminate after reset							
\$002A	Timer 1 Channel 1 Register Low (T1CH1L)	Read: Write:	Bit 7	6	5	4	3	2	1	Bit 0	
	See page 270.	Reset:		<u> </u>		Indetermina	te after reset				
	Timer 2 Status and Control	Read:	TOF			0	0				
\$002B	Register (T2SC)	Write:	0	TOIE	TSTOP	TRST		PS2	PS1	PS0	
	See page 265.	Reset:	0	0	1	0	0	0	0	0	
	Timer 2 Counter	Read:	Bit 15	14	13	12	11	10	9	Bit 8	
\$002C	Register High (T2CNTH)	Write:									
	See page 266.	Reset:	0	0	0	0	0	0	0	0	
				= Unimplem	nented						

Figure 19-3. TIM I/O Register Summary (Sheet 1 of 2)

MC68HC908GZ16 • MC68HC908GZ8 Data Sheet, Rev. 4



**Timer Interface Module (TIM)** 

#### 19.4.3 Output Compare

With the output compare function, the TIM can generate a periodic pulse with a programmable polarity, duration, and frequency. When the counter reaches the value in the registers of an output compare channel, the TIM can set, clear, or toggle the channel pin. Output compares can generate TIM CPU interrupt requests.

## 19.4.3.1 Unbuffered Output Compare

Any output compare channel can generate unbuffered output compare pulses as described in 19.4.3 Output Compare. The pulses are unbuffered because changing the output compare value requires writing the new value over the old value currently in the TIM channel registers.

An unsynchronized write to the TIM channel registers to change an output compare value could cause incorrect operation for up to two counter overflow periods. For example, writing a new value before the counter reaches the old value but after the counter reaches the new value prevents any compare during that counter overflow period. Also, using a TIM overflow interrupt routine to write a new, smaller output compare value may cause the compare to be missed. The TIM may pass the new value before it is written.

Use the following methods to synchronize unbuffered changes in the output compare value on channel x:

- When changing to a smaller value, enable channel x output compare interrupts and write the new
  value in the output compare interrupt routine. The output compare interrupt occurs at the end of
  the current output compare pulse. The interrupt routine has until the end of the counter overflow
  period to write the new value.
- When changing to a larger output compare value, enable TIM overflow interrupts and write the new
  value in the TIM overflow interrupt routine. The TIM overflow interrupt occurs at the end of the
  current counter overflow period. Writing a larger value in an output compare interrupt routine (at
  the end of the current pulse) could cause two output compares to occur in the same counter
  overflow period.

#### 19.4.3.2 Buffered Output Compare

Channels 0 and 1 can be linked to form a buffered output compare channel whose output appears on the TCH0 pin. The TIM channel registers of the linked pair alternately control the output.

Setting the MS0B bit in TIM channel 0 status and control register (TSC0) links channel 0 and channel 1. The output compare value in the TIM channel 0 registers initially controls the output on the TCH0 pin. Writing to the TIM channel 1 registers enables the TIM channel 1 registers to synchronously control the output after the TIM overflows. At each subsequent overflow, the TIM channel registers (0 or 1) that control the output are the ones written to last. TSC0 controls and monitors the buffered output compare function, and TIM channel 1 status and control register (TSC1) is unused. While the MS0B bit is set, the channel 1 pin, TCH1, is available as a general-purpose I/O pin.

#### NOTE

In buffered output compare operation, do not write new output compare values to the currently active channel registers. User software should track the currently active channel to prevent writing a new value to the active channel. Writing to the active channel registers is the same as generating unbuffered output compares.



#### 19.4.4 Pulse Width Modulation (PWM)

By using the toggle-on-overflow feature with an output compare channel, the TIM can generate a PWM signal. The value in the TIM counter modulo registers determines the period of the PWM signal. The channel pin toggles when the counter reaches the value in the TIM counter modulo registers. The time between overflows is the period of the PWM signal.

As Figure 19-4 shows, the output compare value in the TIM channel registers determines the pulse width of the PWM signal. The time between overflow and output compare is the pulse width. Program the TIM to clear the channel pin on output compare if the state of the PWM pulse is logic 1. Program the TIM to set the pin if the state of the PWM pulse is logic 0.

The value in the TIM counter modulo registers and the selected prescaler output determines the frequency of the PWM output. The frequency of an 8-bit PWM signal is variable in 256 increments. Writing \$00FF (255) to the TIM counter modulo registers produces a PWM period of 256 times the internal bus clock period if the prescaler select value is \$000. See 19.9.1 TIM Status and Control Register.

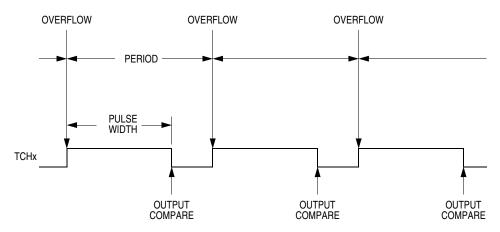


Figure 19-4. PWM Period and Pulse Width

The value in the TIM channel registers determines the pulse width of the PWM output. The pulse width of an 8-bit PWM signal is variable in 256 increments. Writing \$0080 (128) to the TIM channel registers produces a duty cycle of 128/256 or 50%.

#### 19.4.4.1 Unbuffered PWM Signal Generation

Any output compare channel can generate unbuffered PWM pulses as described in 19.4.4 Pulse Width Modulation (PWM). The pulses are unbuffered because changing the pulse width requires writing the new pulse width value over the old value currently in the TIM channel registers.

An unsynchronized write to the TIM channel registers to change a pulse width value could cause incorrect operation for up to two PWM periods. For example, writing a new value before the counter reaches the old value but after the counter reaches the new value prevents any compare during that PWM period. Also, using a TIM overflow interrupt routine to write a new, smaller pulse width value may cause the compare to be missed. The TIM may pass the new value before it is written.

MC68HC908GZ16 • MC68HC908GZ8 Data Sheet, Rev. 4 Freescale Semiconductor 261



Ta	hla	20-2	Mode	Differer	202
17	DIE	/U-/-	IVIC)CIE	imierei	10:65

	Functions									
Modes	Reset Vector High	Reset Vector Low	Break Vector High	Break Vector Low	SWI Vector High	SWI Vector Low				
User	\$FFFE	\$FFFF	\$FFFC	\$FFFD	\$FFFC	\$FFFD				
Monitor	\$FEFE	\$FEFF	\$FEFC	\$FEFD	\$FEFC	\$FEFD				

#### 20.3.1.4 Data Format

Communication with the monitor ROM is in standard non-return-to-zero (NRZ) mark/space data format. Transmit and receive baud rates must be identical.



Figure 20-11. Monitor Data Format

#### 20.3.1.5 Break Signal

A start bit (logic 0) followed by nine logic 0 bits is a break signal. When the monitor receives a break signal, it drives the PTA0 pin high for the duration of two bits and then echoes back the break signal.

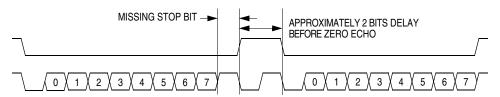


Figure 20-12. Break Transaction

#### 20.3.1.6 Baud Rate

The communication baud rate is controlled by the crystal frequency or external clock and the state of the PTB4 pin (when  $\overline{IRQ}$  is set to  $V_{TST}$ ) upon entry into monitor mode. If monitor mode was entered with  $V_{DD}$  on  $\overline{IRQ}$  and the reset vector blank, then the baud rate is independent of PTB4.

Table 20-1 also lists external frequencies required to achieve a standard baud rate of 7200 bps. The effective baud rate is the bus frequency divided by 278. If using a crystal as the clock source, be aware of the upper frequency limit that the internal clock module can handle. See 21.7 5.0-Volt Control Timing or 21.6 3.3-Vdc Electrical Characteristics for this limit.

#### 20.3.1.7 Commands

The monitor ROM firmware uses these commands:

- READ (read memory)
- WRITE (write memory)
- IREAD (indexed read)
- IWRITE (indexed write)
- READSP (read stack pointer)
- RUN (run user program)

MC68HC908GZ16 • MC68HC908GZ8 Data Sheet, Rev. 4